# NEXA FLOOR PRIMER EPOX WET

Fast epoxy primer for damp substrates

### **Description:**

An epoxy-based primer designed for damp substrates with up to 98% moisture content.

When used as a primer outdoors, sprinkle dry sand on the fresh layer to prevent bubble formation.

Product temperature should not exceed 86 °F (30 °C), as this accelerates the reaction and reduces the pot life of the mixture. Improper treatment of cracks and singular points may reduce the pavement's lifespan.

## **Approved Uses**

- Epoxy primer.
- Primer for substrate leveling (with added sand) for multilayer systems or subsequent application of epoxy or polyurethane systems indoors.
- Binder for producing synthetic mortars with quartz sand for repairs, fillings, and self-leveling mortars.

### **Approved Substrates**

Concrete, cement mortar.

Can be applied to damp substrates and "green" concrete. For substrates in contact with the ground, a correctly installed and intact waterproof barrier must be present. For special substrate conditions or requirements, consult the technical department.

### **Advantages**

- Excellent penetration and adhesion.
- 100% solids.
- Low viscosity.
- Multi-purpose product:
  - Primer
  - Self-leveling
  - Leveling mortar
  - Dry mortar
  - Rough paint

#### Limitations

- Not recommended for waterproofing chemically treated swimming pools.
- On non-porous substrates like ceramic tiles or marble, primer application is required.
- Do not clean the substrate with bleach or highly corrosive products.
- Do not apply to substrates with moisture, as this causes whitening and adhesion loss due to efflorescence brought to the surface by water.

### **Application**

- Substrate Conditions: The substrate must be porous concrete, free of laitance, and without curing agents, with a minimum compressive strength of 2175 psi (15 N/mm²) and a minimum tensile strength of 145 psi (1 N/mm²).
- Cleaning: The substrate must be clean, free of grease, dust, and with appropriate porosity.
- Mixing: The two components must be mixed with a low-speed electric mixer (300-400 rpm) to prevent air entrapment.
- Mixing Time: Stir Component A, add Component B, and mix for at least 1 minute until a homogeneous mixture is achieved.
- Pot Life: Approximately 20 minutes at 68 °F (20 °C) and 55% relative humidity.
- Application Methods: Can be applied using a brush, roller, or metal/rubber spreaders. If necessary, dilute with a maximum of 10% solvent.
- Recoating Time: 2-24 hours, depending on the previous layer and environmental conditions. Do not recoat after 48 hours.
- Drying Times: Touch dry: 2 hours

Pedestrian traffic: 4-6 hours

Light traffic: 1 day Full cure: 7 days

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#### Consumption

- Standard Application: 0.05-0.08 lb/ft² (250-400 g/m²) per coat, depending on the application method, porosity, and roughness of the substrate.
- Synthetic Mortars: For resin-to-aggregate ratios of 1/6 to 1/9, the consumption is approximately 0.41 lb/ft² (2 kg/m²) per millimeter of thickness.

## **Cleaning**

• Clean tools immediately after use with solvent.

## **Presentation and Colors**

Batch Size: 44 lb (20 kg):

• Component A: 35.2 lb (16 kg)

Component B: 8.8 lb (4 kg)

• Batch Size: 11 lb (5 kg):

Component A: 8.8 lb (4 kg)

Component B: 2.2 lb (1 kg)

### **Container Stability**

12 months in a dry place between (5°C and 25°C).

# Transportation, Preventive measures and Storage

Refer to the safety data sheet.

The information provided serves as a recommendation based on laboratory tests and our current knowledge. Different conditions on construction sites may result in variations from the given information; therefore, our warranty is limited to the supplied product. For any questions, please contact our technical department.

Technical Data of the Liquid Product	
CONCEPTS	RESULTS
Density	86.2 lb/ft³ (1.38 g/cm³)
Viscosity	1200 cps
Pot Life (77 °F / 25 °C)	20 minutes
Recoat Time (77 °F / 25 °C)	2-24 hours
Touch Dry Time	2 hours
Full Cure	7 days

Technical Data of the Membrane	
CONCEPTS	RESULTS
Substrate Temperature	>46.4 °F to <77 °F (>8 °C to <25 °C)
Ambient Temperature	>46.4 °F to <86 °F (>8 °C to <30 °C)
Relative Humidity	<80%
Substrate Moisture	<98%
Compressive Strength	7252 psi (>50 N/mm²)
Flexural Strength	2900 psi (>20 N/mm²)
Adhesion Strength (Dry/Wet)	>290 psi (>2 N/mm²)